

ADS62P45, ADS62P44 ADS62P43, ADS62P42

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Dual Channel 14-Bit, 125/105/80/65 MSPS ADC with

Parallel CMOS/DDR LVDS outputs

FEATURES

- Maximum Sample Rate: 125 MSPS
- 14-bit Resolution with No Missing Codes
- 92 dB Crosstalk at 50MHz
- Parallel CMOS and DDR LVDS Output Options
- 3.5 dB Coarse Gain and Programmable Fine Gain up to 6 dB for SNR/SFDR trade-off
- Supports Sine, LVPECL, LVDS & CMOS clock inputs & amplitude down to 400 mV p-p
- Digital Processing Block with
 - Offset correction
 - Fine gain correction, (0.05 dB step)
 - Decimation by 2/4/8
 - Built-in & Custom programmable 24-tap Low / High / Band pass filters

- Clock duty cycle stabilizer
- Internal reference, supports external reference also
- 64-QFN Package (9mm x 9mm)
- Pin compatible 12-bit family (ADS62P2X)

Table 1 ADS62PXX Dual Channel Family

| 100 | | | | |
|--------|----------|----------|----------|----------|
| | 125 MSPS | 105 MSPS | 80 MSPS | 65 MSPS |
| 14 bit | ADS62P45 | ADS62P44 | ADS62P43 | ADS62P42 |
| 12 bit | ADS62P25 | ADS62P24 | ADS62P23 | ADS62P22 |
| 11 bit | ADS62P15 | - | - | - |
| | | | | |

| | | ADS62P45 | ADS62P44 | ADS62P43 | ADS62P42 |
|-------------|---------------------------|----------|----------|----------|----------|
| SFDR, dBc | Fin = 10 MHz | 92 | 92 | 94 | 94 |
| | Fin = 170 MHz, 3.5dB gain | 81 | 82 | 83 | 84 |
| SINAD, dBFS | Fin = 10 MHz | 73.8 | 73.8 | 73.9 | 74 |
| | Fin = 170 MHz, 3.5dB gain | 70.3 | 70.3 | 70.6 | 70.6 |
| Powe | r, mW per channel | 396 | 350 | 294 | 259 |

Table 2 Performance Summary

DESCRIPTION

ADS62P4X is a family of dual channel 14-bit A/D converters with maximum sample rates up to 125 MSPS. It combines high performance and low power consumption in a compact 64 QFN package. Using an internal sample and hold and low jitter clock buffer, the ADC supports high SNR and high SFDR at high input frequencies. It has coarse and fine gain options that can be used to improve SFDR performance at lower full-scale input ranges.





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ADS62P4X includes a digital processing block that consists of several useful & commonly used digital functions such as ADC offset correction, fine gain correction (in steps of 0.05 dB), decimation by 2,4,8 & in-built & custom programmable filters. By default, the digital processing block is bypassed & its functions are disabled.

Two output interface options exist – parallel CMOS and DDR LVDS (Double Data Rate). ADS62P4X includes internal references while traditional reference pins and associated decoupling capacitors have been eliminated. The device also supports an external reference mode. The device is specified over the industrial temperature range (-40°C to +85°C).



PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.





PRODUCT PREVIEW

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PACKAGE/ORDERING INFORMATION (1)

| PRODUCT | PACKAGE- | PACKAGE | SPECIFIED | ECO | LEAD/BALL | PACKAGE | ORDERING | TRANSPORT |
|----------|----------|------------|--------------|---------------|-----------|---------|-------------|-----------|
| | LEAD | DESIGNATOR | TEMPERATURE | PLAN | FINISH | MARKING | NUMBER | MEDIA, |
| | | | RANGE | (2) | | | | QUANTITY |
| ADS62P45 | QFN-64 | RGC | -40C to +85C | GREEN | Cu NiPdAu | AZ62P45 | ADS62P45RGC | TUBE |
| ADS62P44 | QFN-64 | RGC | -40C to +85C | (RoHS & no | | AZ62P44 | ADS62P44RGC | TUBE |
| ADS62P43 | QFN-64 | RGC | -40C to +85C | Sb/Br) | | AZ62P43 | ADS62P43RGC | TUBE |
| ADS62P42 | QFN-64 | RGC | -40C to +85C | | | AZ62P42 | ADS62P42RGC | TUBE |

(1) θ JA = TBD, θ JC = TBD.

(2) Eco Plan - The planned eco-friendly classification: Green (RoHS & no Sb/Br) : TI defines "Green" to mean Pb-Free (RoHS compatible) and free of Bromine (Br) and Antimony (Sb) based flame retardants.





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ABSOLUTE MAXIMUM RATINGS (1)

| | VALUE | UNIT |
|--|--------------------------------------|------|
| Supply voltage range, AVDD | - 0.3 V to 3.9 | V |
| Supply voltage range, DRVDD | -0.3 V to 3.9 | V |
| Voltage between AGND and DRGND | -0.3 to 0.3 | V |
| Voltage between AVDD to DRVDD | -0.3 to 3.3 | V |
| Voltage applied to external pin, CM (in external reference mode) | -0.3 to 2.0 | V |
| Voltage applied to analog input pins, INA_P, INA_M, INB_P, INB_M | -0.3V to minimum(3.6, AVDD + 0.3V) | V |
| Voltage applied to clock input pins, CLKP, CLKM | -0.3V to AVDD + 0.3V | V |
| Operating free-air temperature range, TA | -40 to 85 | °C |
| Operating junction temperature range, TJ | 125 | °C |
| Storage temperature range, Tstg | -65 to 150 | °C |
| Lead temperature 1.6 mm (1/16 ") from the case for 10 seconds | 220 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to thedevice. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.







PRODUCT PREVIEW

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RECOMMENDED OPERATING CONDITIONS

| | PARAMETER | MIN | TYP | MAX | UNIT |
|---|--|------|------------------|------|------|
| SUPPLIES | | | | | |
| AVDD Analog supply voltage | | 3.0 | 3.3 | 3.6 | V |
| DRVDD Digital supply voltage | CMOS interface | 1.65 | 1.8 to 3.3 | 3.6 | V |
| | LVDS interface | 3.0 | 3.3 | 3.6 | V |
| ANALOG INPUTS | | | | | |
| Differential input voltage range | | | 2 | | Vpp |
| Input common-mode voltage | | | 1.5 +/- 0.1 | | V |
| Voltage applied on CM in extern | al reference mode | | 1.5 ± 0.05 | | V |
| CLOCK INPUT | | | | | |
| | ADS62P45 | 1 | | 125 | MSPS |
| Innut clock complexate. Fo | ADS62P44 | | | 105 | MSPS |
| Input clock sample rate, Fs | ADS62P43 | 1 | | 80 | MSPS |
| | ADS62P42 | 1 | | 65 | MSPS |
| | Sine wave, ac-coupled | 0.3 | 3.0 | | V pp |
| | LVPECL, ac-coupled | | 1.6 | | V pp |
| Input Clock amplitude differential (VCLKP-VCLKM) | LVDS, ac-coupled | | 0.7 | | V pp |
| | LVCMOS, single-ended, ac-coupled | | 3.3 | | V |
| Input clock duty cycle | | 35 % | 50 % | 65 % | |
| DIGITAL OUTPUTS | | | | | |
| | For CLOAD <= 5 pF and DRVDD >= 2.2V | | Default strength | | |
| Output buffer drive strength | For C _{LOAD} > 5 pF and DRVDD > 2.2V | | Maximum strength | | |
| | For DRVDD < 2.2V | | Maximum strength | | |
| Cload, | CMOS interface | | | 5 | pF |
| Maximum external load | LVDS interface, without internal termination | | | 5 | pF |
| capacitance from each output pin to DRGND | LVDS interface, with 100 Ω internal termination | | | 10 | pF |
| R _{LOAD,} Differential load resistance betw | een the LVDS output pairs (LVDS mode) | | 100 | | Ω |
| Operating free-air temperature, | T _A | -40 | | 85 | °C |





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ELECTRICAL CHARACTERISTICS

Typical values at 25C, min & max values are across the full temperature range T_{MIN} = -40C to T_{MAX} = 85C, AVDD = 3.3V, DRVDD = 1.8V to 3.3V, 50% clock duty cycle, -1dBFS differential analog input, internal reference, applies to CMOS & LVDS interfaces unless otherwise noted.

| PARAMETER | | DS62P4 25 MSP | | | .DS62P4 05 MSP | | | ADS62P4 80 MSP3 | | | ADS62P4 | | UNIT |
|--|--------------|------------------|-----|-----|-------------------|------------|-----|--------------------|-----|-----|---------|-----|------|
| | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | мах | MIN | TYP | MAX | |
| Resolution | | | 14 | | | 14 | | | 14 | | | 14 | bits |
| Analog Input | | | 1 | 1 | 1 | | | 1 | 1 | | 1 | | |
| Differential input voltage range | | 2.0 | | | 2.0 | | | 2.0 | | | 2.0 | | V рр |
| Differential input resistance (at dc), see Figure 10 | | 1 | | | 1 | \bigcirc | | 1 | | | 1 | | MΩ |
| Differential input capacitance, see Figure 11 | | 7 | | | 7 | | | 7 | | | 7 | | pF |
| Analog input bandwidth | | 450 | | | 450 | | • | 450 | | | 450 | | MHz |
| Analog input common mode current (per input pin of each channel) | | 165 | | | 140 | | | 110 | | | 91 | | μA |
| VCM common mode voltage output | | 1.5 | | | 1.5 | | | 1.5 | | | 1.5 | | V |
| VCM output current capability | \cap | 4 | | | 4 | | | 4 | | | 4 | | mA |
| Power Supply | \mathbf{N} | | | | | | | | | | | | |
| IAVDD Analog supply current | | 232 | | | 205 | | | 172 | | | 152 | | mA |
| IDRVDD Output buffer supply current, CMOS interface 2.5MHz input signal, no load capacitance ⁽¹⁾ | * | 15 | | | 13 | | | 10.5 | | | 9 | | mA |
| Total power – CMOS interface, DRVDD = 1.8V | | 792 | TBD | | 700 | TBD | | 587 | TBD | | 518 | TBD | mW |
| Total power – LVDS interface, DRVDD = 3.3V | | TBD | | | TBD | | | TBD | | | TBD | | mW |
| Global power down | | 50 | TBD | | 50 | TBD | | 50 | TBD | | 50 | TBD | mW |

(1) In CMOS mode, the DRVDD current scales with the sampling frequency and the load capacitance on output pins.





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ELECTRICAL CHARACTERISTICS

Typical values at 25C, min & max values are across the full temperature range T_{MIN} = -40C to T_{MAX} = 85C, AVDD = 3.3V, DRVDD = 3.3V, 50% clock duty cycle, -1dBFS differential analog input, internal reference, applies to CMOS & LVDS interfaces, unless otherwise noted.

| | | ADS62P4 | 5 | A | ADS62P44 | 1 | A | DS62P4 | 3 | | ADS62P42 | 2 | |
|---|-----------|-------------|-----------|----------|------------|-----------|------------------|---------|-----|-----|----------|-----|--------|
| PARAMETERS | | 125 MSP | S | 1 | 105 MSPS | 6 | | 80 MSPS | | | 65 MSPS | | UNIT |
| | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| DC ACCURACY | | | | | | | | | | | | | |
| No Missing Codes | | Assured | | | Assured | | | Assured | | | Assured | | |
| DNL Differential Non-Linearity | TBD | +/- 0.8 | TBD | TBD | +/- 0.7 | TBD | TBD | +/- 0.5 | TBD | TBD | +/- 0.4 | TBD | LSB |
| INL Integral Non-Linearity | TBD | +/- 3 | TBD | TBD | +/- 2.5 | TBD | TBD | +/-1.5 | TBD | TBD | +/-1.5 | TBD | LSB |
| Offset Error | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | mV |
| Offset error temperature coefficient | | TBD | | | твр | | $\left(\right)$ | TBD | | | TBD | | µV/ ∘C |
| Offset error variation with supply | | TBD | • | | TBD | | Ť | TBD | | | TBD | | mV/V |
| There are two sources of gain e | error – i | nternal ref | erence in | accuracy | / and char | nnel gair | n error | | I | 1 | | 1 | |
| Gain error due to internal reference inaccuracy alone | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | % FS |
| Reference gain error temperature coefficient | | TBD | | | TBD | | | TBD | | | TBD | | ∆%/ °C |
| Gain error of channel alone (1) | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | % FS |
| Channel gain error temperature coefficient | | TBD | | | TBD | | | TBD | | | TBD | | ∆%/ °C |
| Gain matching | | TBD | | | TBD | | | TBD | | | TBD | | |

(1) This is specified by design and characterization; it is not tested in production.





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ELECTRICAL CHARACTERISTICS

| | | | А | DS62P | 45 | А | DS62P | 44 | А | DS62P4 | 43 | А | DS62P | 42 | |
|------------------------|---------------------|--------------|-----|--------|-----|--------|--------|------------|-----|--------|-----|-----|--------|-----|------|
| F | ARAMET | ERS | | 25 MSF | | | 05 MSF | | | BO MSP | | | 65 MSP | | UNIT |
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| Dynamic Ch | aracteristi | cs | | | | | | | | | | | | | |
| | Fin= 10M | Hz | | 74.3 | | | 74.3 | | | 74.4 | | | 74.5 | | |
| | Fin = 50M | IHz | TBD | 73.8 | | | 73.8 | | TBD | 74.1 | | | 74.2 | | |
| SNR | Fin = 70M | Hz | | 73.6 | | TBD | 73.6 | \bigcirc | | 74 | | TBD | 74.1 | | |
| Signal to noise ratio, | Fin = | 0 dB gain | | 71.8 | | | 71.8 | X | | 72.5 | | | 72.5 | | dBFS |
| CMOS | 170MHz | 3.5 dB gain | | 71 | | | 71 | | | 71.4 | | | 71.4 | | |
| | Fin = | 0 dB gain | | 71 | | \sim | 71 | * | | 72 | | | 72 | | |
| | 230MHz | 3.5 dB gain | | 70 | | | 70 | | | 71 | | | 71 | | |
| | Fin= 10M | Hz | | 74.5 | | • | 74.5 | | | 74.6 | | | 74.7 | | |
| | Fin = 50M | IHz | TBD | 74 | | | 74 | | TBD | 74.3 | | | 74.4 | | |
| SNR | Fin = 70M | IHz | | 73.8 | | TBD | 73.8 | | | 74.2 | | TBD | 74.3 | | |
| Signal to noise ratio, | Fin = 170MHz | 0 dB gain | | 72.1 | | | 72.1 | | | 72.7 | | | 72.7 | | dBFS |
| LVDS | TTOMHZ | 3.5 dB gain | | 71 | | | 71 | | | 71.8 | | | 71.8 | | |
| | Fin = 230MHz | 0 dB gain | | 71.2 | | | 71 | | | 72.2 | | | 72.2 | | |
| | 2301/1172 | 3.5 dB gain | | 70.1 | | | 70.1 | | | 71.2 | | | 71.2 | | |
| RMS output noise | Inputs tied mode | d to common- | | 0.96 | | | 0.96 | | | 0.96 | | | 0.96 | | LSB |





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ELECTRICAL CHARACTERISTICS

| | | | А | DS62P | 45 | А | DS62P | 44 | А | DS62P4 | 43 | А | DS62P4 | 42 | |
|---|-----------------|-------------|--------------|--------|-----|-----|--------|-----|-----|--------|-----|-----|--------|-----|------|
| F | PARAMETE | ERS | | 25 MSF | | | 05 MSF | | | 80 MSP | | | 5 MSP | | UNIT |
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| | Fin= 10MI | Hz | | 73.8 | | | 73.8 | | | 73.9 | | | 74 | | |
| | Fin = 50M | Hz | TBD | 73.2 | | | 73.2 | | TBD | 73.6 | | | 73.7 | | |
| SINAD Signal to | Fin = 70M | Hz | | 73 | | TBD | 73 | | | 73.4 | | TBD | 73.5 | | |
| noise & distortion | Fin = | 0 dB gain | | 70.6 | | | 70.7 | | | 71.5 | | | 71.5 | | dBFS |
| ratio, CMOS | 170MHz | 3.5 dB gain | | 70.1 | | | 70.2 | | | 70.6 | | | 70.6 | | |
| | Fin = 230MHz | 0 dB gain | | 68.7 | | | 68.7 | | | 69.7 | | | 69.9 | | |
| | 23010112 | 3.5 dB gain | | 68.4 | | | 68.5 | | | 69.5 | | | 69.6 | | |
| | Fin= 10MI | Hz | | 74 | | | 74 | | | 74.1 | | | 74.1 | | |
| | Fin = 50M | lHz | TBD | 73.4 | | | 73.4 | | TBD | 73.8 | | | 73.8 | | |
| SINAD Signal to | Fin = 70M | IHz | \mathbf{O} | 73.2 | | TBD | 73.4 | | | 73.6 | | TBD | 73.6 | | |
| noise & distortion | Fin = 170MHz | 0 dB gain | | 70.8 | | | 70.8 | | | 71.7 | | | 71.6 | | dBFS |
| ratio, LVDS | TTOWINZ | 3.5 dB gain | | 70.5 | | | 70.5 | | | 70.8 | | | 70.7 | | |
| | Fin = 230MHz | 0 dB gain | | 68.9 | | | 68.9 | | | 68.1 | | | 68 | | |
| | 23010112 | 3.5 dB gain | | 68.6 | | | 68.7 | | | 69.7 | | | 69.7 | | |
| ENOB, Effective number of bits | Fin = 50 N | ЛНz | TBD | 11.8 | | | 11.8 | | TBD | 11.9 | | | 12 | | LSB |





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ELECTRICAL CHARACTERISTICS

| | | | | DS62P | | | DS62P | | | DS62P4 | | | DS62P4 | | |
|-------------------|-----------------|-------------|-----------|--------|-----|-----|--------|-----|--------|--------|-----|-----|--------|-----|------|
| PARAMETE | ERS | | | 25 MSF | | | 05 MSF | | | 80 MSP | | | 65 MSP | | UNIT |
| | T | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| | Fin= 10M | Hz | | 92 | | | 92 | | | 94 | | | 94 | | |
| | Fin = 50M | Hz | TBD | 82 | | | 82 | | TBD | 88 | | | 88 | | |
| SFDR Spurious | Fin = 70M | Hz | | 85 | | TBD | 86 | | | 86 | | TBD | 86 | | |
| Free Dynamic | Fin = 170MHz | 0 dB gain | | 79 | | | 80 | | | 81 | | | 82 | | dBc |
| Range | TTOWINZ | 3.5 dB gain | | 81 | | | 82 | | | 83 | | | 84 | | |
| | Fin = 230MHz | 0 dB gain | | 76 | | | 78 | | * • | 79 | | | 80 | | |
| | 23010112 | 3.5 dB gain | | 78 | | | 80 | | | 81 | | | 82 | | |
| | Fin= 10M | Hz | | 90 | | | 90 | | | 92 | | | 92 | | |
| | Fin = 50M | IHz | TBD | 80.5 | | | 80.5 | | TBD | 86 | | | 86 | | |
| THD, | Fin = 70M | IHz | λ | 83.5 | | TBD | 84 | | | 84 | | TBD | 84 | | |
| Total Harmonic | Fin = 170MHz | 0 dB gain | | 76 | | | 77 | | | 78 | | | 79 | | dBc |
| Distortion | | 3.5 dB gain | | 78 | | | 79 | | | 80 | | | 81 | | |
| | Fin = 230MHz | 0 dB gain | | 73 | | | 75 | | | 76 | | | 77 | | |
| | 20010112 | 3.5 dB gain | | 75 | | | 77 | | | 78 | | | 79 | | |





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ELECTRICAL CHARACTERISTICS

| PARAMET | ERS | | | DS62P 25 MSF | | | DS62P 05 MSF | | | DS62P4 | | | DS62P4 | | UNIT |
|--------------------|-----------------|-------------|----------------------------|-----------------|-----|-----|-----------------|-----|-----|--------|-----|-----|--------|-----|------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | - |
| | Fin= 10MH | łz | | 94 | | | 94 | | | 96 | | | 96 | | |
| | Fin = 50Mł | Hz | TBD | 85 | | | 85 | | TBD | 90 | | | 90 | | |
| HD2 | Fin = 70Mł | Ηz | | 88 | | TBD | 88 | | | 88 | | TBD | 88 | | |
| Second Harmonic | Fin = | 0 dB gain | | 79 | | | 80 | | | 81 | | | 82 | | dBc |
| Distortion | 170MHz | 3.5 dB gain | | 81 | | | 82 | | | 83 | | | 84 | | |
| | Fin = | 0 dB gain | | 76 | | | 78 | X | | 79 | | | 80 | | |
| | 230MHz | 3.5 dB gain | | 78 | | | 80 | | | 81 | | | 82 | | |
| | Fin= 10MH | lz | | 92 | | | 92 | | | 94 | | | 94 | | |
| | Fin = 50Mł | Hz | TBD | 82 | | | 82 | | TBD | 88 | | | 88 | | |
| HD3 Third | Fin = 70Mł | Hz | | 85 | | TBD | 86 | | | 86 | | TBD | 86 | | |
| Harmonic | Fin = | 0 dB gain | $\boldsymbol{\mathcal{N}}$ | 79 | | | 80 | | | 81 | | | 82 | | dBc |
| טופוט | 170MHz | 3.5 dB gain | | 81 | | | 82 | | | 83 | | | 84 | | |
| | Fin = 230MHz | 0 dB gain | | 76 | | | 78 | | | 79 | | | 80 | | |
| | 230101112 | 3.5 dB gain | | 78 | | | 80 | | | 81 | | | 82 | | |





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ELECTRICAL CHARACTERISTICS

| | | A | DS62P | 45 | А | DS62P | 44 | A | DS62P | 43 | А | DS62P | 42 | |
|----------------------------|--|-----|--------|-----|-----|--------|-----|-----|--------|-----|-----|--------|-----|-----------------|
| PARAMETERS | 6 | - | 25 MSF | 1 | | 05 MSF | 1 | | BO MSP | | | 65 MSP | | UNIT |
| | [| MIN | TYP | MAX | |
| | Fin= 10MHz | | 96 | | | 96 | | | 98 | | | 98 | | |
| Worst Spur | Fin = 50MHz | | 88 | | | 88 | | | 92 | | | 94 | | |
| Other than second, third | Fin = 70MHz | | 91 | | | 91 | | | 91 | | | 91 | | dBc |
| harmonics | Fin = 170MHz | | 83 | | | 84 | | | 85 | | | 86 | | |
| | Fin = 230MHz | | 85 | | | 86 | | | 87 | | | 88 | | |
| IMD | F1 = 46 MHz, | | | | | | | • | | | | | | |
| 2-Tone Intermodulation | F2 = 50 MHZ, | | 95 | | | 95 | | | 98 | | | 98 | | dBFS |
| Distortion | each tone at -7 dBFS | | | | | | | | | | | | | |
| Input Overload recovery | Recovery to within 1% (of final value) for 6-dB overload with sine wave input | | 1 | | | 1 | | | 1 | | | 1 | | clock cycles |
| Cross-talk | Cross-talk signal frequency = 10 MHZ | | 100 | | | 100 | | | 100 | | | 100 | | dB |
| UUSS-IdIK | Cross-talk signal frequency = 50 MHZ | | 95 | | | 95 | | | 95 | | | 95 | | dB |
| PSRR | | | | | | | | | | | | | | |
| AC Power | For 100 mV pp, 1MHz | | TBD | | | TBD | | | TBD | | | TBD | | dBc |
| Supply Rejection Ratio | signal on AVDD supply | | | | | | | | | | | | | ubc |





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DIGITAL CHARACTERISTICS

The DC specifications refer to the condition where the digital outputs are not switching, but are permanently at a valid logic level 0 or 1. AVDD=3.3V, DRVDD=1.8V to 3.3V, unless otherwise specified.

| PARAMETER | CONDITIONS | | ADS62P45 / ADS62P44 / ADS62P43 / ADS62P42 | | | |
|---|---|------------|--|-----|------|--|
| | | MIN | TYP | MAX | UNIT | |
| DIGITAL INPUTS | | 1 | | | L | |
| High-level input voltage | | 2.4 | | | V | |
| Low-level input voltage | | | | 0.8 | V | |
| High-level input current | | \bigcirc | 33 | | μA | |
| Low-level input current | | | -33 | | μΑ | |
| Input capacitance | | | 4 | | pF | |
| DIGITAL OUTPUTS - CMOS MODE | | | · · · · | | | |
| High-level output voltage | | | DRVDD | | V | |
| Low-level output voltage | | | 0 | | V | |
| Output capacitance (internal to device) | | | 2 | | pF | |
| DIGITAL OUTPUTS - LVDS MODE | ⁽²⁾ , DRVDD = 3.3V | | | | | |
| High-level output voltage | | | 1375 | | mV | |
| Low-level output voltage | | | 1025 | | mV | |
| Output Differential Voltage, VoD | | | 350 | | mV | |
| Vos Output Offset Voltage | Common-mode voltage of OUTP and OUTM | | 1200 | | mV | |
| Output Capacitance | Output capacitance inside the device, from either output to ground | | 2 | | pF | |

(1) LVDS buffer current setting, $I_0 = 3.5 \text{ mA}$

(2) External differential load resistance between the LVDS output pairs, R_{LOAD} = 50 Ω





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TIMING CHARACTERISTICS - LVDS AND CMOS MODES (1)

Typical values at 25C, min and max values are across the full temperature range TMIN = -40C to TMAX = 85C, AVDD = 3.3V, DRVDD = 1.8V

to 3.3V, 3.0 Vpp sine wave input clock, C_{LOAD} = 5pF ⁽²⁾, I_0 = 3.5mA, R_{LOAD} = 100 Ω ⁽³⁾, no internal termination, unless otherwise noted.

| | CONDITIONS | A | DS62P4 | 45 | A | DS62P | 44 | A | DS62P | 43 | A | DS62P | 42 | UNIT |
|---|--|-----|--------|--------|----------------------------|-------|-----|-----|-------|-----|-----|-------|-----------------|-----------------|
| PARAMETER | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| t _a , Aperture delay | | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | TBD | ns |
| tj, Aperture jitter | | | 130 | | | 130 | | | 130 | | | 130 | | fs rms |
| | from power down global | | 15 | | | 15 | | | 15 | | | 15 | | μs |
| Wake-up time | from channel standby | | 100 | | | 100 | | | 100 | | | 100 | | ns |
| | from output buffer disable | | 100 | | | 100 | | | 100 | | | 100 | | ns |
| Latency Low latency mode | Default | | 14 | | | 14 | | | 14 | | | 14 | | Clock cycles |
| | | 10 | | \sim | 10 | | | 10 | | | 10 | | Clock cycles | |
| DDR LVDS INTER | ACE (4) DRVDD = 3.3 | V | | | $\boldsymbol{\mathcal{N}}$ | | | | | | | | - | |
| t _{su} Data setup time ⁽⁵⁾ | Data valid ⁽⁶⁾ to zero-crossing of CLKOUTP | TBD | 15 | | TBD | 2.3 | | TBD | 3.8 | | TBD | 5.2 | | ns |
| t _h Data hold time ⁽⁵⁾ | Zero-crossing of CLKOUTP to data becoming invalid ⁽⁶⁾ | TBD | 2.3 | | TBD | 2.3 | | TBD | 2.3 | | TBD | 2.3 | | ns |
| t _{PDI} Clock propagation delay | Input clock rising edge cross-over to output clock rising edge cross-over | TBD | 5.5 | TBD | TBD | 5.5 | TBD | TBD | 5.5 | TBD | TBD | 5.5 | TBD | ns |
| LVDS bit clock duty cycle | Duty cycle of differential clock | | 50% | | | 50% | | | 50% | | | 50% | | |
| t _{RISE,} t _{FALL} Data rise time, Data fall time | Rise time measured from -100mV to | | 110 | | | 110 | | | 110 | | | 110 | | ps |
| tcLKRISE, tcLKFALL Output clock rise time, Output clock fall time | +100mV, Fall time measured from +100mV to - 100mV | | 120 | | | 120 | | | 120 | | | 120 | | ps |

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| [| | Δ | DS62P | 45 | Δ | DS62P | 44 | Δ | DS62P | 43 | Δ | DS62P | 42 | |
|---|---|-----|-------|-----|-----|-------|-----|-----|-------|-----|-----|-------|-----|------|
| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNIT |
| PARALLEL CMOS IN | I ITERFACE, DRVDD = 2.5 | | | | | | | | | | | | | |
| t _{su} Data setup time ⁽⁵⁾ | Data valid ⁽⁷⁾ to zero- crossing of CLKOUT | TBD | 3.5 | | TBD | 4.3 | | TBD | 5.8 | | TBD | 7.2 | | ns |
| th Data hold time ⁽⁵⁾ | Zero-crossing of CLKOUT to data becoming invalid ⁽⁷⁾ | TBD | 3.2 | | TBD | 4 | | TBD | 5.5 | | TBD | 7 | | ns |
| t _{PDI} Clock propagation delay | Input clock rising edge cross-over to output clock rising edge cross-over | TBD | 7.3 | TBD | ns |
| Output clock duty cycle | Duty cycle of output clock, CLKOUT | | 53 | | | 53 | | | 53 | | | 53 | | |
| trise, t _{FALL} Data rise time, Data fall time | Rise time measured from 20% to 80% of DRVDD, Fall time measured from 80% to 20% of DRVDD | | 1.5 | | | 1.5 | | | 1.5 | | | 1.5 | | ns |
| t _{CLKRISE} , t _{CLKFALL} Output clock rise time, Output clock fall time | Rise time measured from 20% to 80% of DRVDD Fall time measured from 80% to 20% of DRVDD | | 1.5 | | | 1.5 | | | 1.5 | | | 1.5 | | ns |

Notes:

- 1. Timing parameters are ensured by design and characterization and not tested in production.
- 2. CLOAD is the effective external single-ended load capacitance between each output pin and ground
- 3. Io refers to the LVDS buffer current setting; RLOAD is the differential load resistance between the LVDS output pair.
- 4. Measurements are done with a transmission line of 100Ω characteristic impedance between the device and the load.
- 5. Setup and hold time specifications take into account the effect of jitter on the output data and clock. These specifications also assume that the data and clock paths are perfectly matched within the receiver. Any mismatch in these paths within the receiver would appear as reduced timing margin.
- 6. Data valid refers to LOGIC HIGH of +100.0mV and LOGIC LOW of -100.0mV.
- 7. Data valid refers to LOGIC HIGH of 2.0V and LOGIC LOW of 0.8V for DRVDD = 3.3V &

LOGIC HIGH of 1.7V and LOGIC LOW of 0.7V for DRVDD = 2.5V.





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*Dn – Bits D0 to D11

Figure 4 CMOS mode timing

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DEVICE CONFIGURATION

ADS62P4X can be configured independently using either parallel interface control or serial interface programming.

USING PARALLEL INTERFACE CONTROL ONLY

To control the device using parallel interface, keep RESET tied to high (AVDD).

Pins SEN, SCLK, CTRL1, CTRL2 and CTRL3 can be used to directly control certain functions of the ADC. After power-up, the device will automatically get configured as per the parallel pin voltage settings (Table 4 to Table 6).

In this mode, SEN and SCLK function as parallel analog control pins, which can be configured using a simple resistor divider as shown in Figure 5. The table below has a description of the modes controlled by the parallel pins.

Table 3 PARALLEL PIN DEFINITION

| Type of pin Controls modes |
|---|
| Analog control pins (controlled by analog Coarse gain and Internal/external reference |
| voltage levels, see Figure 5). LVDS/CMOS interface and Output Data Format |
| Disital control size (controlled by Visital and |
| Digital control pins (controlled by digital logic Together control various power down modes and levels) MUX mode. |
| ivex indue. |
| |

USING SERIAL INTERFACE PROGRAMMING ONLY

To program the device using the serial interface, keep RESET low.

Pins SEN, SDATA, and SCLK function as serial interface digital pins and are used to access the internal registers of ADC. The registers must first be reset to their default values either by applying a pulse on RESET pin or setting bit <RST> = 1. After reset, the RESET pin must be kept low.

The serial interface section describes the register programming and register reset in more detail. Since the parallel pins (CTRL1, CTRL2, CTRL3) are not used in this mode, they must be tied to ground.





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USING BOTH SERIAL INTERFACE AND PARALLEL CONTROLS

For increased flexibility, a combination of serial interface registers and parallel pin controls (CTRL1 to CTRL3) can also be used to configure the device. To allow this, keep RESET low.

The parallel interface control pins CTRL1 to CTRL3 are available. After power-up, the device will automatically get configured as per the voltage settings on these pins (Table 6).

SEN, SDATA, and SCLK function as serial interface digital pins and are used to access the internal registers of ADC. The registers must first be reset to their default values either by applying a pulse on RESET pin or by setting bit <RST> = 1. After reset, the RESET pin must be kept low. The serial interface section describes the register programming and register reset in more detail.

Since the power down modes can be controlled using both the parallel pins and serial registers, the priority between the two is determined by <OVRD> bit. When <OVRD> bit = 0, pins CTRL1 to CTRL3 control the power down modes. With <OVRD> = 1, register bits <POWER DOWN> control these modes, over-riding the pin settings.

DETAILS OF PARALLEL CONFIGURATION ONLY

The functions controlled by each parallel pin are described below

Table 4 SCLK (ANALOG CONTROL PIN)

| SCLK | DESCRIPTION |
|------------|--|
| 0 | 0dB gain and Internal reference |
| (3/8)AVDD | 0dB gain and External reference |
| (5/8)2AVDD | 3.5dB Coarse gain and External reference |
| AVDD | 3.5dB Coarse gain and Internal reference |
| | |

Table 5 SEN (ANALOG CONTROL PIN)

| SEN | DESCRIPTION |
|-----------|---|
| 0 | 2's complement format and DDR LVDS output |
| (3/8)AVDD | Straight binary and DDR LVDS output |
| (5/8)AVDD | Straight binary and parallel CMOS output |
| AVDD | 2' s complement format and parallel CMOS output |





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Table 6 CTRL1, CTRL2 and CTRL3 (DIGITAL CONTROL PINS)

| CTRL1 | CTRL2 | CTRL3 | DESCRIPTION |
|-------|-------|-------|--|
| LOW | LOW | LOW | Normal operation |
| LOW | LOW | HIGH | Channel A output buffer disabled |
| LOW | HIGH | LOW | Channel B output buffer disabled |
| LOW | HIGH | HIGH | Channel A and B output buffer disabled |
| HIGH | LOW | LOW | Power global down |
| HIGH | LOW | HIGH | Channel A standby |
| HIGH | HIGH | LOW | Channel B standby |
| HIGH | HIGH | HIGH | MUX mode of operation, Channel A and B data is multiplexed and output on |
| TIGH | 11011 | 11011 | DB13 to DB0 pins. See Multiplexed output mode for detailed description. |



Figure 5 Simple scheme to configure analog control pins (SCLK, SEN)





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SERIAL INTERFACE

The ADC has a set of internal registers, which can be accessed by the serial interface formed by pins SEN (Serial interface Enable), SCLK (Serial Interface Clock) and SDATA (Serial Interface Data).

Serial shift of bits into the device is enabled when SEN is low. Serial data SDATA is latched at every falling edge of SCLK when SEN is active (low). The serial data is loaded into the register at every 16th SCLK falling edge when SEN is low. In case the word length exceeds a multiple of 16 bits, the excess bits are ignored. Data can be loaded in multiple of 16-bit words within a single active SEN pulse.

The first 8 bits form the register address & the remaining 8 bits the register data. The interface can work with SCLK frequency from 20 MHz down to very low speeds (few Hertz) and also with non-50% SCLK duty cycle.

Register Initialization

After power-up, the internal registers must be initialized to their default values. This can be done in one of two ways -

 Either through hardware reset by applying a high-going pulse on RESET pin (of width greater than 10ns) as shown in Figure 6

OR

 By applying software reset. Using the serial interface, set bit <RST> = 1. This initializes internal registers to their default values and then self-resets the <RST> bit to low. In this case, keep RESET pin low.



Figure 6 Serial Interface Timing



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SERIAL INTERFACE TIMING CHARACTERISTICS

Typical values at 25C, min and max values across the full temperature range T_{MIN} = -40C to T_{MAX} = 85C, AVDD = 3.3V, DRVDD = 1.8V to 3.3V, unless otherwise noted.

| | PARAMETER | MIN | TYP | MAX | UNIT |
|-----------------|------------------------|------|-----|-----|------|
| fsclk | SCLK frequency | > DC | | 20 | MHz |
| tsloads | SEN to SCLK setup time | 25 | | | ns |
| t SLOADH | SCLK to SEN hold time | 25 | | | ns |
| tDS | SDATA setup time | 25 | | | ns |
| tDH | SDATA hold time | 25 | | | ns |
| | | | | | |

RESET TIMING

Typical values at 25C, min and max values across the full temperature range T_{MIN} = -40C to T_{MAX} = 85C, unless otherwise noted.

| | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNIT |
|-----|----------------------|--|-----|-----|-----|------|
| t1 | Power-on delay | Delay from power-up of AVDD and DRVDD to RESET pulse active | 5 | | | ms |
| t2 | Reset pulse width | Pulse width of active RESET signal | 10 | | | ns |
| t3 | Register write delay | Delay from RESET disable to SEN active | 25 | | | ns |
| tро | Power-up time | Delay from power-up of AVDD and DRVDD to output stable | | 7 | | ms |





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Note: A high-going pulse on RESET pin is required in serial interface mode in case of initialization through hardware reset. For parallel interface operation, RESET has to be tied permanently HIGH.

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SERIAL REGISTER MAP

Table 7 Summary of functions supported by serial interface (1) (2)

| REGISTER ADDRESS | | | | REGISTER FUNC | TIONS | | | | | | |
|---------------------|--|----|---|---|---|------|---|---------|--|--|--|
| A7 - A0 IN HEX | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | |
| 00 | 0 | 0 | 0 | 0 | 0 | 0 | <rst> Software Reset</rst> | 0 | | | |
| 10 | <clkout STRENGTH></clkout | | 0 | 0 | 0 | 0 | 0 | 0 | | | |
| 11 | 0 | 0 | | <current double=""> <lvds current=""> LVDS buffer current double LVDS buffer current <dataout str<="" td=""> programmability</dataout></lvds></current> | | | | | | | |
| 12 | 0 | 0 | | <lvd< td=""><td>S TERMINATION></td><td></td><td></td><td></td></lvd<> | S TERMINATION> | | | | | | |
| 12 | 0 | Ū | | Internal termination programmability | | | | | | | |
| 13 | 0 | 0 | 0 | <offset FREEZE></offset | 0 | 0 | 0 | 0 | | | |
| 14 | <ovrd> Over-ride bit</ovrd> | 0 | <output INTERFACE> LVDS or CMOS interface</output | <coarse gain=""> 3.5 dB gain</coarse> | <ref> Internal / External reference</ref> | | <power down="" modes=""></power> | | | | |
| 16 | 0 | 0 | | <data format=""> 2s complement or straight binary</data> | Bit/Byte wise (LVDS only) | | <test patterns=""></test> | | | | |
| 17 | 0 | 0 | 0 | 0 | 0 to | | INE GAIN> gain in 0.5 dB steps | | | | |
| 18 | | | | <custom low=""> Lo</custom> | ower 8 bits | | | | | | |
| 19 | 0 | 0 | | <custc< td=""><td>M HIGH> Upper 6</td><td>bits</td><td></td><td></td></custc<> | M HIGH> Upper 6 | bits | | | | | |
| 1A | <low LATENCY></low | | <pre><offset correction<="" offset="" pre=""></offset></pre> | | | | CORRECTION> B, steps of 0.05 dB | | | | |
| 1B | <offset en=""> Offset correction enable</offset> | 0 | <filter coeff<br="">SELECT> In-built or custom coefficients</filter> | <decimation Enable> Enable decimation</decimation | <odd tap<br="">Enable></odd> | | <decimation rate=""> Decimate by 2,4,8</decimation> | | | | |
| 1D | 0 | 0 | 0 | 0 | 0 | 0 | <decimation filt<br="">BANDS></decimation> | ER FREQ | | | |
| 1E to 2F | | | | <filter coeffic<="" td=""><td></td><td></td><td></td><td></td></filter> | | | | | | | |
| | | | | 12 coefficients, each 1 | 2 bit signed | | | | | | |

1) Multiple functions in a register can be programmed in a single write operation.





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DESCRIPTION OF SERIAL REGISTERS

| A7 - A0 (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------------|----|----|----|----|----|----|--------------------------------|----|
| 00 | 0 | 0 | 0 | 0 | 0 | 0 | <rst> Software Reset</rst> | 0 |

D1 <RST>

1 Software reset applied – resets all internal registers and self-clears to 0.

| A7 - A0 (hex) | D7 | D6 | D5 D4 | D3 | D2 | D1 | D0 |
|------------------|---|-----|-------|----|----|----|----|
| 10 | <clkout s<="" th=""><th>0 0</th><th>0</th><th>0</th><th>0</th><th>0</th></clkout> | 0 0 | 0 | 0 | 0 | 0 | |

D7-D6 <CLKOUT STRENGTH> Output clock buffer drive strength control

01 WEAKER than default drive

00 DEFAULT drive strength

11 STRONGER than default drive strength (recommended for load capacitances > 5 pF)

10 MAXIMUM drive strength (recommended for load capacitances > 5 pF)

| A7 - A0 (hex) | D7 | D6 | D5 D4 | D3 | D2 | D1 | D0 |
|------------------|----|----|--|---|------------|--|-----------|
| 11 | 0 | 0 | <current double=""> LVDS buffer current double</current> | <lvds cu<br="">LVDS buff program</lvds> | er current | <dataout :<="" td=""><td>STRENGTH></td></dataout> | STRENGTH> |

D1-D0 <DATAOUT STRENGTH> Output data buffer drive strength control

- 01 WEAKER than default drive
- 00 DEFAULT drive strength
- 11 STRONGER than default drive strength (recommended for load capacitances > 5 pF)

10 MAXIMUM drive strength (recommended for load capacitances > 5 pF)

D3-D2 <LVDS CURRENT> LVDS Current programmability

- 00 3.5mA
- 01 2.5mA
- 10 4.5mA
- 11 1.75mA



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D5-D4 <CURRENT DOUBLE> LVDS Current double control

- 00 default current, set by <LVDS CURR>
- 01 LVDS clock buffer current is doubled, 2x <LVDS CURR>
- 10 LVDS data & clock buffers current are doubled, 2x <LVDS CURR>
- 11 unused

| A7 - A0 (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---|--|----|------------------------|-------------------|---------------------------------|----|----|----|
| 12 | 0 | 0 | | Inte | LVDS TERMI ernal termination | | | |
| D5-D3 000 001 010 011 100 101 110 111 | <lvds da<sup="">* No internal 300 Ω 180 Ω 110 Ω 150 Ω 100 Ω 81 Ω 60 Ω</lvds> | | > Internal termination | | | | | |
| D2-D0 000 011 010 011 100 101 110 111 | <lvds clh<br="">No internal 300 Ω 180 Ω 110 Ω 150 Ω 100 Ω 81 Ω 60 Ω</lvds> | | Internal termination o | control for clock | output | | | |





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| A7 - A0 (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------------|----|----|----|-----------------------------|----|----|----|----|
| 13 | 0 | 0 | 0 | <offset freeze=""></offset> | 0 | 0 | 0 | 0 |

D4 <OFFSET FREEZE> Offset correction becomes inactive and the last estimated offset value is used to cancel the offset

- 0 Offset correction active
- 1 Offset correction inactive

| A7 - A0 (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------------|-------------------------------------|----|---|---|---|----|-------------------|----|
| 14 | <ovrd> Over-ride bit</ovrd> | 0 | <output INTERFACE> LVDS or CMOS interface</output | <coarse GAIN> 3.5 dB gain</coarse | <ref> Internal / External reference</ref> | | OWER DO MODES> | WN |

D2-D0 <POWER DOWN MODES>

- 000 Normal operation
- 001 Channel A output buffer disabled
- 010 Channel B output buffer disabled
- 011 Channel A & B output buffers disabled
- 100 Power down global
- 101 Channel A standby
- 110 Channel B standby
- Multiplexed mode, MUX- (only with CMOS interface)Channel A and B data is multiplexed and output on DB13 to DB0 pins.
- D3 <REF> Reference mode
- 0 Internal reference enabled
- 1 External reference enabled
- D4 <COARSE GAIN> Coarse gain control
- 0 0 dB coarse gain
- 1 3.5 dB coarse gain





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- D5 <OUTPUT INTERFACE> Output Interface selection
- 0 Parallel CMOS data outputs
- 1 DDR LVDS data outputs
- D7 <OVRD> Over-ride bit the power down modes can also be controlled using parallel pins. By setting <OVRD> = 1, register bits <POWER DOWN MODES> will over-ride the settings of the parallel pins.
- 0 Disable over-ride pins CTRL1 to CTRL3 control power down modes.
- 1 Enable over-ride bits < POWER DOWN MODES> control power down modes.

| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | _ | | | | | | | | | |
|--|---|----|----|----|----|---|-----------------------------|---|---------|------|
| 16 0 0 0 State Sta | | | D7 | D6 | D5 | D4 | Ba | D2 | D1 | D0 |
| | | 16 | 0 | 0 | 0 | <pre><data format=""> 2s complement or straight binary</data></pre> | Bit / Byte wise (LVDS only) | <tes< td=""><td>T PATTE</td><td>RNS></td></tes<> | T PATTE | RNS> |

D2-D0 <TEST PATTERNS> Test Patterns to verify capture

- 000 Normal ADC operation
- 001 Outputs all zeros
- 010 Outputs all ones
- 011 Outputs toggle pattern
- 100 Outputs digital ramp_
- 101 Outputs custom pattern
- 110 Unused
- 111 Unused
- D3 Bit-wise/Byte-wise selection (DDR LVDS mode ONLY)
- 0 Bit wise Even bits (D0, D2, D4, D6, D8, D10, D12) on CLKOUT rising edge and Odd bits (D1, D3, D5, D7, D9, D11, D13) on CLKOUT falling edge
- 1 Byte wise Lower 7 bits (D0-D6) at CLKOUT rising edge and Upper 7 bits (D7-D13) at CLKOUT falling edge
- D4 <DATA FORMAT> Data format selection
- 0 2s complement
- 1 Straight binary





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| A7 - A0 (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------------|----|----|----|----|--|----|----|----|
| 17 | 0 | 0 | 0 | 0 | <fine gain=""> 0 to 6 dB gain in 0.5 dB steps</fine> | | | |

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D3-D0 <FINE GAIN> Gain programmability in 0.5 dB steps

| 0000 | 0 dB gain, default after reset | | | | | | | |
|--------|--------------------------------|-------------------|---------------|-------------------|---------------|--------------|------|----|
| 0001 | 0.5 dB gain | | | | | | | |
| 0010 | 1.0 dB gain | | | | | | | |
| 0011 | 1.5 dB gain | | | | | | | |
| 0100 | 2.0 dB gain | | | 4 | | | | |
| 0101 | 2.5 dB gain | | | | | | | |
| 0110 | 3.0 dB gain | | | | | | | |
| 0111 | 3.5 dB gain | | • | | | | | |
| 1000 | 4.0 dB gain | | | $\setminus igvee$ | | | | |
| 1001 | 4.5 dB gain | | | | • | | | |
| 1010 | 5.0 dB gain | | | | | | | |
| 1011 | 5.5 dB gain | | \sim \sim | | | | | |
| 1100 | 6.0 dB gain | | | | | | | |
| Others | Unused | $\langle \rangle$ | | | | | | |
| | A7 - A0 | | | | 5.0 | 2.0 | 5. | |
| | (hex) D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| | 18 | | < | CUSTOM LO | N> Lower 8 bi | ts | | |
| | 19 0 | 0 | | <(| CUSTOM HIG | H> Upper 6 b | vits | |
| | | | | | | | | |
| D7-D0 | <custom low=""></custom> | • | | | | | | |
| | 8 lower bits of custom | pattern availab | le at the out | put instead o | t ADC data. | | | |
| D5-D0 | <custom high=""></custom> | | | | | | | |
| | 6 upper bits of custom | i pattern availab | le at the out | put instead o | of ADC data | | | |





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| | 7 - A0 hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|--|---|------------------------|----------------------|-------------------------|---------------|---|------------|-------------|--------|
| | 1A | <low latency=""></low> | Offset | <offset tc=""></offset> | onstant | <gain correction=""> 0 to 0.5 dB, steps of 0.05 dB</gain> | | | |
| D3-D0 | <gain co<="" th=""><th>RRECTION> Enables</th><th>fine gain correctio</th><th>n in steps of 0.</th><th>05 dB (same</th><th>correction</th><th>applies to</th><th>both cha</th><th>nnels)</th></gain> | RRECTION> Enables | fine gain correctio | n in steps of 0. | 05 dB (same | correction | applies to | both cha | nnels) |
| 0000 | 0 dB | | - | | · | | | | |
| 0001 | +0.05 dB | | | | | | | | |
| 0010 | +0.10 dB | | | | | | | | |
| 0011 | +0.15 dB | | | | | | | | |
| 0100 | +0.20 dB | | | - | | | | | |
| 0101 | +0.25 dB | | | | | | | | |
| 0110 | +0.30 dB | | | | | | | | |
| 0111 | +0.35 dB | | | | | | | | |
| 1000 | +0.40 dB | | | | | | | | |
| | 00 0.2 | | | | · · | | | | |
| 1000 | +0.45 dB | | | | | | | | |
| 1001 | | | | \mathbb{N} | | | | | |
| 1001 1010 | +0.45 dB +0.5 dB | TC>, Time constant | of offset correction | n in number o | f clock cycle | s (second | s, for sam | npling frec | quency |
| 1001 1010 D6-D4 | +0.45 dB +0.5 dB <offset< td=""><td>TC>, Time constant</td><td>of offset correction</td><td>n in number o</td><td>f clock cycle</td><td>s (second</td><td>s, for sam</td><td>npling frec</td><td>quency</td></offset<> | TC>, Time constant | of offset correction | n in number o | f clock cycle | s (second | s, for sam | npling frec | quency |
| 1001 1010 D6-D4 125MS | +0.45 dB +0.5 dB <offset< td=""><td>TC>, Time constant</td><td>of offset correction</td><td>n in number o</td><td>f clock cycle</td><td>s (second</td><td>s, for san</td><td>npling frec</td><td>quency</td></offset<> | TC>, Time constant | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 | +0.45 dB +0.5 dB <offset PS)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 001 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s)</offset | | of offset correction | n in Number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 001 010 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s) 2²⁵ (0.27 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 001 010 011 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s) 2²⁵ (0.27 s) 2²⁴ (0.13 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 001 010 011 100 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s) 2²⁵ (0.27 s) 2²⁴ (0.13 s) 2²⁸ (2.15 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 001 010 011 100 101 110 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s) 2²⁵ (0.27 s) 2²⁴ (0.13 s) 2²⁸ (2.15 s) 2²⁹ (4.3 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | quency |
| 1001 1010 D6-D4 125MS 000 001 010 011 100 101 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s) 2²⁵ (0.27 s) 2²⁴ (0.13 s) 2²⁸ (2.15 s) 2²⁹ (4.3 s) 2²⁷ (1.1 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | Juency |
| 1001 1010 D6-D4 125MS 000 001 010 011 100 101 110 111 | +0.45 dB +0.5 dB <offset PS) 2²⁷ (1.1 s) 2²⁶ (0.55 s) 2²⁵ (0.27 s) 2²⁴ (0.13 s) 2²⁸ (2.15 s) 2²⁹ (4.3 s) 2²⁷ (1.1 s) 2²⁷ (1.1 s)</offset | | of offset correction | n in number o | f clock cycle | s (second | s, for san | npling frec | luency |





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| A7 - A0 (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------------|--|----|---|---|------------------------------|----|-----------------------------|----|
| 1B | <offset enable=""> Offset correction enable</offset> | 0 | <filter coeff<br="">SELECT> In-built or custom coefficients</filter> | <decimation Enable> Enable decimation</decimation | <odd enable="" tap=""></odd> | | ECIMATI RATE> mate by | |

D2-D0 <DECIMATION RATE>

- 000 Decimate by 2 (pre-defined or user coefficients can be used)
- 001 Decimate by 4 (pre-defined or user coefficients can be used)
- 011 No decimation (Pre-defined coefficients are disabled, only custom coefficients are available)
- 100 Decimate by 8 (Only custom coefficients are available)
- D3 <ODD TAP ENABLE>
- 0 Even taps enabled (24 coefficients)
- 1 Odd taps enabled (23 coefficients)
- D4 <DECIMATION ENABLE>
- 0 Decimation disabled
- 1 Decimation enabled

D5 <FILTER COEFF SELECT>

- 0 Pre-defined coefficients are loaded in the filter
- 1 User-defined coefficients are loaded in the filter (coefficients have to be loaded in registers to)

D7 <OFFSET Enable>

- 0 Offset correction disabled
- 1 Offset correction enabled



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| A7 - A((hex) | | D7 | D6 | D5 | D4 | D3 | D2 | D1 | | D0 | |
|--|-----------------|-------------------------------------|---|--------------------|---------|----------------|-----|---|--------------|---------------|----|
| 1D | | 0 | 0 | 0 | 0 | 0 | 0 | <deci< td=""><td>MATION FILTE</td><td>R FREQ BANDS></td><td>•</td></deci<> | MATION FILTE | R FREQ BANDS> | • |
| 00 01 | With d Low p | lecimate ass filte bass filte | 0N FILTE e by 2, < er (-6 dB er (-6 dB | DECIMA frequenc | TION RA | ATE> = 0 .) | 00: | | | | |
| With decimate by 4, <decimation rate=""> = 001:</decimation> Low pass filter (-3 dB frequency at Fs/8) Band pass filter (center frequency at 3Fs/16) Band pass filter (center frequency at 5Fs/16) High pass filter (-3 dB frequency at 3Fs/8) | | | | | | | | | | | |
| A7 - A0 (hex) | | D7 | | D6 | i | 05 | D4 | D3 | D2 | D1 | D0 |
| 1E to 2F | - | | | | | | | m FIR coefficients See Table 14 | | | |
| | | | | | X | | | | | | |





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PIN DESCRIPTION (CMOS INTERFACE)







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PIN ASSIGNMENTS (CMOS INTERFACE)

| Pin Name | Description | Pin Number | Number of pins |
|--------------|---|---------------|----------------------|
| AVDD | Analog power supply | | |
| AGND | Analog ground | | |
| CLKP, CLKM | Differential input clock | | |
| INP_A, INM_A | Differential input signal – channel A | | |
| INP_B, INM_B | Differential input signal – channel B | | |
| VCM | Internal reference mode – Common-mode voltage output. 🔺 | | |
| | External reference mode – Reference input. The voltage forced on | | |
| | this pin sets the ADC internal references. | | |
| RESET | Serial interface RESET input. | | |
| | In serial interface mode, the user MUST initialize internal registers through | | |
| | hardware RESET by applying a high-going pulse on this pin or by using software | | |
| | reset (refer to Serial Interface section). | | |
| | In parallel interface mode, the user has to tie RESET pin permanently HIGH. | | |
| | (SCLK, SDATA and SEN are used as parallel pin controls in this mode) | | |
| | The pin has an internal 100K Ω pull-down resistor. | | |
| SCLK | This pin functions as serial interface clock input when RESET is low. | | |
| | It functions as analog control pin when RESET is tied high & controls coarse gain | | |
| | and internal/external reference selection. See Table 4 for details. | | |
| | This pin has an internal pull-down resistor to ground. | | |
| SDATA | This pin functions as serial interface data input when RESET is low. | | |
| | This pin has an internal pull-down resistor to ground. | | |
| SEN | This pin functions as serial interface enable input when RESET is low. | | |
| | It functions as analog control pin when RESET is tied high & controls the output | | |
| | interface (LVDS/CMOS) and data format selection. See Table 5 for details. | | |
| | This pin has an internal pull-up resistor to AVDD. | | |
| CTRL1 | These are digital logic input pins. They control various power down and multiplexed | | |
| CTRL2 | mode. See Table 6 for details. | | |
| CTRL3 | | | |
| DA13 to DA0 | Channel A 14-bit data outputs, CMOS | | |
| DB13 to DB0 | Channel B 14-bit data outputs, CMOS | | |
| CLKOUT | CMOS Output clock | | |
| DRVDD | Digital supply | | |
| DRGND | Digital ground | | |
| PAD | Digital ground. Solder the pad to the digital ground on the board using multiple vias | | |





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| | for good electrical & thermal performance. | |
|----|--|--|
| NC | Do not connect | |





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PIN DESCRIPTION (LVDS INTERFACE)






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PIN ASSIGNMENTS (LVDS INTERFACE)

| Pin Name | Description | Pin Number | Number of pins |
|--------------|---|---------------|----------------|
| AVDD | Analog power supply | | |
| AGND | Analog ground | | |
| CLKP, CLKM | Differential input clock | | |
| INP_A, INM_A | Differential input signal – Channel A | | |
| INP_B, INM_B | Differential input signal – Channel B | | |
| VCM | Internal reference mode – Common-mode voltage output. | | |
| | External reference mode – Reference input. The voltage forced on | | |
| | this pin sets the ADC internal references. | | |
| RESET | Serial interface RESET input. | | |
| | In serial interface mode, the user MUST initialize internal registers through | | |
| | hardware RESET by applying a high-going pulse on this pin or by using | | |
| | software reset (refer to Serial Interface section). | | |
| | In parallel interface mode, the user has to tie RESET pin permanently HIGH. | | |
| | (SCLK, SDATA and SEN are used as parallel pin controls in this mode) | | |
| | The pin has an internal 100K Ω pull-down resistor. | | |
| SCLK | This pin functions as serial interface clock input when RESET is low. | | |
| | It functions as analog control pin when RESET is tied high & controls coarse | | |
| | gain and internal/external reference selection. See Table 4 for details. | | |
| | This pin has an internal pull-down resistor to ground. | | |
| SDATA | This pin functions as serial interface data input when RESET is low. | | |
| | This pin has an internal pull-down resistor to ground. | | |
| SEN | This pin functions as serial interface enable input when RESET is low. | | |
| | It functions as analog control pin when RESET is tied high & controls the | | |
| | output interface (LVDS/CMOS) and data format selection. See Table 5 for | | |
| | details. | | |
| | This pin has an internal pull-up resistor to AVDD. | | |
| CTRL1 | These are digital logic input pins. Together they control various power | | |
| CTRL2 | down and multiplexed mode. See Table 6 for details. | | |
| CTRL3 | | | |
| NC | Do not connect | | |



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| Pin Name | Description | Pin Number | Number of pins |
|----------|---|------------|-------------------|
| DA0P | Channel A Differential output data D0 & D1, true | | • |
| DA0M | Channel A Differential output data D0 & D1 , complement | | |
| DA2P | Channel A Differential output data D2 & D3 , true | | |
| DA2M | Channel A Differential output data D2 & D3 , complement | | |
| DA4P | Channel A Differential output data D4 & D5 , true | | |
| DA4M | Channel A Differential output data D4 & D5 , complement | | |
| DA6P | Channel A Differential output data D6 & D7 , true | | |
| DA6M | Channel A Differential output data D6 & D7 , complement | | |
| DA8P | Channel A Differential output data D8 & D9 , true | | |
| DA8M | Channel A Differential output data D8 & D9 , complement | | |
| DA10P | Channel A Differential output data D10 & D11 , true | | |
| DA10M | Channel A Differential output data D10 & D11, complement | | |
| DA12P | Channel A Differential output data D12 & D13, true | | |
| DA12M | Channel A Differential output data D12 & D13 , complement | | |
| CLKOUTP | Differential output clock, true | | |
| CLKOUTM | Differential output clock, complement | | |
| DB0P | Channel B Differential output data D0 & D1 , true | | |
| DB0M | Channel B Differential output data D0 & D1 , complement | | |
| DB2P | Channel B Differential output data D2 & D3 , true | | |
| DB2M | Channel B Differential output data D2 & D3 , complement | | |
| DB4P | Channel B Differential output data D4 & D5 , true | | |
| DB4M | Channel B Differential output data D4 & D5 , complement | | |
| DB6P | Channel B Differential output data D6 & D7 , true | | |
| DB6M | Channel B Differential output data D6 & D7 , complement | | |
| DB8P | Channel B Differential output data D8 & D9 , true | | |
| DB8M | Channel B Differential output data D8 & D9 , complement | | |
| DB10P | Channel B Differential output data D10 & D11 , true | | |
| DB10M | Channel B Differential output data D10 & D11 , complement | | |
| DB12P | Channel B Differential output data D12 & D13 , true | | |
| DB12M | Channel B Differential output data D12 & D13 , complement | | |
| DRVDD | Digital supply | | |
| DRGND | Digital ground | | |
| PAD | Digital ground. Solder the pad to the digital ground on the board using | | |
| | multiple vias for good electrical & thermal performance. | | |





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APPLICATION INFORMATION

THEORY OF OPERATION

ADS62P4X is a low power 14 bit dual channel pipeline ADC family fabricated in a CMOS process using switched capacitor techniques.

The conversion process is initiated by a rising edge of the external input clock. Once the signal is captured by the input sample & hold, the input sample is sequentially converted by a series of small resolution stages, with the outputs combined in a digital correction logic block. At every clock edge the sample propagates through the pipeline resulting in a data latency of 14 clock cycles. The output is available as 14-bit data, in DDR LVDS or CMOS and coded in either straight offset binary or binary 2s complement format.

ANALOG INPUT

The analog input consists of a switched-capacitor based differential sample and hold architecture. This differential topology results in very good AC performance even for high input frequencies at high sampling rates. The INP and INM pins have to be externally biased around a common-mode voltage of 1.5V, available on VCM pin 13. For a full-scale differential input, each input pin INP, INM has to swing symmetrically between VCM + 0.5V and VCM - 0.5V, resulting in a 2Vpp differential input swing. The maximum swing is determined by the internal reference voltages REFP (2.5V nominal) and REFM (0.5V, nominal).



Figure 8 Analog Input Equivalent Circuit





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The input sampling circuit has a high 3-dB bandwidth that extends up to 450 MHz (measured from the input pins to the sampled voltage).

TBD

Figure 9 ADC Analog Bandwidth

Drive Circuit Requirements

For optimum performance, the analog inputs must be driven differentially. This improves the common-mode noise immunity and even order harmonic rejection. A 5 Ω resistor in series with each input pin is recommended to damp out ringing caused by the package parasitics.

It is also necessary to present low impedance (< 50 Ω) for the common mode switching currents. This can be achieved by using two resistors from each input terminated to the common mode voltage (VCM).

In addition to the above, the drive circuit may have to be designed to provide a low insertion loss over the desired frequency range and matched impedance to the source. While doing this, the ADC input impedance must be considered. Figure 10 & Figure 11 show the impedance (Zin = Rin || Cin) looking into the ADC input pins.



Figure 10 ADC Analog Input Resistance (Rin) across frequency





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Figure 11 ADC Analog Input Capacitance (Cin) across frequency

Using RF-Transformer based drive circuits

Figure 12 shows a configuration using a single 1:1 turns ratio transformer (for example, Coilcraft WBC1-1) that can be used for low input frequencies (about 100 MHz). The single-ended signal is fed to the primary winding of the RF transformer. The transformer is terminated on the secondary side. Putting the termination on the secondary side helps to shield the kickbacks caused by the sampling circuit from the RF transformer' s leakage inductances. The termination is accomplished by two resistors connected in series, with the center point connected to the 1.5 V common mode (VCM pin). The value of the termination resistors (connected to common mode) has to be low (< 100 Ω) to provide a low-impedance path for the ADC common-mode switching currents.





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Figure 12 Drive circuit at low input frequencies

At high input frequencies, the mismatch in the transformer parasitic capacitance (between the windings) results in degraded even-order harmonic performance. Connecting two identical RF transformers back-to-back helps minimize this mismatch, and good performance is obtained for high frequency input signals. Figure 13 shows an example using two transformers (Coilcraft WBC1-1). An additional termination resistor pair (enclosed within the shaded box) may be required between the two transformers to improve the balance between the P and M sides. The center point of this termination must be connected to ground.



Figure 13 Drive circuit at high input frequencies





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Using Differential Amplifier drive circuits

Figure 14 shows a drive circuit using a differential amplifier (TI's THS4509) to convert a single-ended input to differential output that can be interface to the ADC analog input pins. In addition to the single-ended to differential conversion, the amplifier also provides gain (10 dB). R_{FIL} helps to isolate the amplifier outputs from the switching input of the ADC. Together with C_{FIL} it also forms a low-pass filter that band-limits the noise (and signal) at the ADC input. As the amplifier output is ac-coupled, the common-mode voltage of the ADC input pins is set using two 200 W resistors connected to VCM.

The amplifier output can also be dc-coupled. Using the output common-mode control of the THS4509, the ADC input pins can be biased to 1.5 V. In this case, use +4 V and -1 V supplies for the THS4509 so that its output common-mode voltage (1.5 V) is at mid-supply.



Figure 14 Drive Circuit using the THS4509

Input common-mode

To ensure a low-noise common-mode reference, the VCM pin is filtered with a 0.1uF low-inductance capacitor connected to ground. The VCM pin is designed to directly drive the ADC inputs. Each input pin of the ADC sinks a common-mode current, about 165 uA (at 125MSPS). Equation 1 describes the dependency of the common-mode current and the sampling frequency.

165µAxFs 125MSPS

Equation 1

This equation helps to design the output capability and impedance of the CM driving circuit accordingly.





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REFERENCE

ADS62P4X has built-in internal references REFP and REFM, requiring no external components. Design schemes are used to linearize the converter load seen by the references; this and the on-chip integration of the requisite reference capacitors eliminates the need for external decoupling. The full-scale input range of the converter can be controlled in the external reference mode as explained below. The internal or external reference modes can be selected by programming the serial interface register bit <REF>.



Internal reference

When the device is in internal reference mode, the REFP and REFM voltages are generated internally. Common-mode voltage (1.5V nominal) is output on VCM pin, which can be used to externally bias the analog input pins.

External reference

When the device is in external reference mode, the VCM acts as a reference input pin. The voltage forced on the VCM pin is buffered and gained by 1.33 internally, generating the REFP and REFM voltages. The differential input voltage corresponding to full-scale is given by Equation 2.

Full-scale differential input pp = (Voltage forced on VCM) x 1.33 Equation 2

In this mode, the 1.5V common-mode voltage to bias the input pins has to be generated externally.





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COARSE GAIN AND PROGRAMMABLE FINE GAIN

ADS62P4X includes gain settings that can be used to get improved SFDR performance (over 0dB gain mode). For each gain setting, the analog input full-scale range scales proportionally, as shown in Table 8.

The coarse gain is a fixed setting of 3.5 dB and is designed to improve SFDR with little degradation in SNR. The fine gain is programmable in 0.5 dB steps from 0 to 6 dB; however the SFDR improvement is achieved at the expense of SNR. So, the programmable fine gain makes it possible to trade-off between SFDR and SNR. The coarse gain makes it possible to get best SFDR but without losing SNR significantly.

The gains can be programmed using the serial interface (bits <COARSE GAIN> and <FINE GAIN>). Note that the default gain after reset is 0dB.

| | Tab | le 8 Full-scale range ac | ross gains |
|--|------------|--------------------------|-----------------|
| | Gain, dB | Туре | Full-Scale, Vpp |
| | 0 | Default after reset | 2V |
| | 3.5 | Coarse (fixed) | 1.34 |
| | 0.5 | | 1.89 |
| | 1.0 | | 1.78 |
| | 1.5 2.0 | Fine (programmable) | 1.68 |
| | | | 1.59 |
| | 2.5 | | 1.50 |
| | 3.0 | | 1.42 |
| | 3.5 | | 1.34 |
| | 4.0 | | 1.26 |
| | 4.5 | · · | 1.19 |
| | 5.0 | | 1.12 |
| | 5.5 | | 1.06 |
| | 6.0 | | 1.00 |





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CLOCK INPUT

The clock inputs can be driven differentially (SINE, LVPECL or LVDS) or single-ended (LVCMOS), with little or no difference in performance between them. The common-mode voltage of the clock inputs is set to VCM using internal 5 k Ω resistors as shown in Figure 16. This allows using transformer-coupled drive circuits for sine wave clock or ac-coupling for LVPECL, LVDS clock sources (Figure 18 and Figure 19).



Figure 16 Internal Clock buffer

TBD









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Figure 18 Differential clock driving circuit

Single-ended CMOS clock can be ac-coupled to the CLKP input, with CLKM (pin 11) connected to ground with a 0.1-µ F capacitor, as shown in Figure 19.



For best performance, the clock inputs have to be driven differentially, reducing susceptibility to common-mode noise. For high input frequency sampling, it is recommended to use a clock source with very low jitter. Bandpass filtering of the clock source can help reduce the effect of jitter. There is no change in performance with a non-50% duty cycle clock input.



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POWER DOWN

ADS62P4X has three power down modes – power down global, channel standby and individual channel output buffer disable. These can be set using either the serial register bits or using the control pins CTRL1 to CTRL3.

| | CON | TOTAL | | | | |
|---|--|---------|------|-------|-------------------|---------------|
| POWER DOWN MODES | SERIAL INTERFACE PARALLEL CONTROL PINS | | | | POWER. | WAKE-UP TIME |
| FOWER DOWN MODES | <power down<br="">MODES></power> | CTRL1 C | | CTRL3 | mW ⁽¹⁾ | WARE-OF TIME |
| Normal operation | 000 | low | low | low | 792 | - |
| Channel A output buffer disabled | 001 | low | low | high | 782 | Fast (100 ns) |
| Channel B output buffer disabled | 010 | low | high | low | 782 | Fast (100 ns) |
| Channel A & B output buffer disabled | 011 | low | high | high | 772 | Fast (100 ns) |
| Power down global | 100 | high | low | low | 50 | Slow (15 µ s) |
| Channel A standby | 101 | high | low | high | 482 | Fast (100 ns) |
| Channel B standby | 110 | high | high | low | 482 | Fast (100 ns) |
| Multiplexed (MUX) mode – Output data of channel A & B is multiplexed & available on DB13 to DB0 pins. | 111 | high | high | high | - | - |

1. Sampling frequency = 125 MSPS, DRVDD = 1.8V

Power down global

In this mode, the entire chip including both the A/D converters, internal reference and the output buffers are powered down resulting in reduced total power dissipation of about 50 mW. The output buffers are in high impedance state. The wake-up time from the global power down to data becoming valid in normal mode is typically 15 µ s.

Channel standby (individual or both channels)

This mode allows the individual ADCs to be powered down. The internal references are active & this results in fast wake-up time, about 100 ns. The total power dissipation in standby is about 482 mW.

Output buffer disable (individual or both channels)

Each channel' s output buffer can be disabled & put in high impedance stateWakeup time is fast, about 100 ns.

Input clock stop

In addition to the above, the converter enters a low-power mode when the input clock frequency falls below 1 MSPS. The power dissipation is about 140 mW.

POWER SUPPLY SEQUENCE

During power-up, the AVDD and DRVDD supplies can come up in any sequence. The two supplies are separated in the device. Externally, they can be driven from separate supplies or from a single supply.





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DIGITAL OUTPUT INFORMATION

ADS62P4X provides 14 bit data per channel and a common output clock synchronized with the data. The output interface can be either parallel CMOS or DDR LVDS voltage levels and can be selected using serial register bit <OUTPUT INTERFACE> or parallel pin SEN.

Parallel CMOS interface

In the CMOS mode, the output buffer supply (DRVDD) can be operated over a wide range from 1.8 V to 3.3 V (typical). Each data bit is output on separate pin as CMOS voltage level, every clock cycle (Figure 20).

For DRVDD > 2.2 V, it is recommended to use the CMOS output clock (CLKOUT) to latch data in the receiving chip. The rising edge of CLKOUT can be used to latch data in the receiver, even at the highest sampling speed. It is recommended to minimize the load capacitance seen by data and clock output pins by using short traces to the receiver. Also, match the output data and clock traces to minimize the skew between them.

For DRVDD < 2.2 V, it is recommended to use external clock (for example, input clock delayed to get desired setup / hold times).



Figure 20 CMOS Output Interface





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Output Buffer Strength Programmability

Switching noise (caused by CMOS output data transitions) can couple into the analog inputs during the instant of sampling and degrade the SNR. The coupling and SNR degradation increases as the output buffer drive is made stronger. To minimize this, ADS62P4X CMOS output buffers are designed with controlled drive strength to get best SNR. The default drive strength also ensures wide data stable window for load capacitances up to 5 pF and DRVDD supply voltage > 2.2 V.

To ensure wide data stable window for load capacitance > 5 pF, there exists option to increase the output data & clock drive strengths using the serial interface (<DATAOUT STRENGTH> & <CLKOUT STRENGTH>). Note that for DRVDD supply voltage < 2.2 V, it is recommended to use maximum drive strength (for any value of load capacitance).

CMOS Interface Power Dissipation

With CMOS outputs, the DRVDD current scales with the sampling frequency and the load capacitance on every output pin. The maximum DRVDD current occurs when each output bit toggles between 0 and 1 every clock cycle. In actual applications, this condition is unlikely to occur. The actual DRVDD current would be determined by the average number of output bits switching, which is a function of the sampling frequency and the nature of the analog input signal.

Digital current due to CMOS output switching = $C_L \times DRVDD \times (N \times F_{AVG})$,

where C_L = load capacitance, N x F_{AVG} = average number of output bits switching.

Figure TBD shows the current with various load capacitances across sampling frequencies at 2 MHz analog input frequency.





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DDR LVDS Interface

The LVDS interface works only with 3.3V DRVDD supply. In this mode, the 14 data bits of each channel and a common output clock are available as LVDS (Low Voltage Differential Signal) levels. Two successive data bits are multiplexed and output on each LVDS differential pair every clock cycle (DDR - Double Data Rate, Figure 22).



Even data bits D0, D2, D4, D6, D8, D10 and D12 are output at the rising edge of CLKOUTP and the odd data bits D1, D3, D5, D7, D9, D11 and D13 are output at the falling edge of CLKOUTP. Both the rising and falling edges of CLKOUTP have to be used to capture all the data bits.



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Figure 22 DDR LVDS interface

LVDS Buffer Current Programmability

The default LVDS buffer output current is 3.5 mA. When terminated by 100 Ω , this results in a 350-mV single-ended voltage swing (700-mVPP differential swing). The LVDS buffer currents can also be programmed to 2.5 mA, 4.5 mA, and 1.75 mA (<LVDS CURRENT>). In addition, there exists a current double mode, where this current is doubled for the data and output clock buffers (register bits <CURRENT DOUBLE>).





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LVDS Buffer Internal Termination

An internal termination option is available (using the serial interface), by which the LVDS buffers are differentially terminated inside the device. The termination resistances available are -300Ω , 185 Ω , and 150 Ω (nominal with ±20% variation). Any combination of these three terminations can be programmed; the effective termination is the parallel combination of the selected resistances. This results in eight effective terminations from open (no termination) to 60 Ω .

The internal termination helps to absorb any reflections coming from the receiver end, improving the signal integrity. With 100 Ω internal and 100 Ω external termination, the voltage swing at the receiver end is halved (compared to no internal termination). The voltage swing can be restored by using the LVDS current double mode. Figure 23 &

TBD

Figure 24 compare the LVDS eye diagrams without and with 100 Ω internal termination. With internal termination, the eye looks clean even with 10 pF load capacitance (from each output pin to ground). The terminations can be programmed using register bits <LVDS TERMINATION>.

Figure 23 LVDS Eye Diagram - No Internal Termination

TBD

Figure 24 LVDS Eye Diagram – With 100Ω Internal Termination

BD

Output Data Format

Two output data formats are supported – 2s complement and straight binary. They can be selected using the serial interface register bit <DATA FORMAT> or controlling the SEN pin in parallel configuration mode.

In the event of an input voltage overdrive, the digital outputs go to the appropriate full scale level. For a positive overdrive, the output code is 0x3FFF in offset binary output format, and 0x1FFF in 2s complement output format. For a negative input overdrive, the output code is 0x0000 in offset binary output format and 0x2000 in 2s complement output format.





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Multiplexed Output mode

This mode is available only with CMOS interface. In this mode, the digital outputs of both the channels are multiplexed and output on a single bus (DA0-DA13 pins), as per the timing diagram shown in Figure 25. The channel B output pins (DB0-DB13) are tri-stated. Since the output data rate on the DB bus is effectively doubled, this mode is recommended only for low sampling frequencies (< 65 MSPS).

This mode can be enabled using register bits <POWER DOWN MODES> or using the parallel pins CTRL1 -3 ().



Figure 25 Multiplexed mode - Output Timing

Low Latency mode

The default latency of ADS62P4X is 14 clock cycles. For applications, which cannot tolerate large latency, ADS62P4X includes a special mode with 10 clock cycles latency. In the low latency condition, the Digital Processing block is bypassed and its features (offset correction, fine gain, decimation filters) are not available.





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DETAILS OF THE DIGITAL PROCESSING BLOCK



Figure 26 Digital Processing Block Diagram

Several common digital processing functions have been integrated in the device – offset correction, fine gain, gain correction decimation & digital filters. By default after reset, the digital processing block is bypassed & all its functions are disabled.

OFFSET CORRECTION

ADS62P4X has an internal offset correction algorithm that estimates and corrects dc offset up to +/-10mV. The correction can be enabled using the serial register bit <OFFSET LOOP EN>. Once enabled, the algorithm estimates the channel offset and applies the correction every clock cycle. The time constant of the correction loop is a function of the sampling clock frequency. The time constant can be controlled using register bits <OFFSET LOOP TC> as described in Table 9.

It is also possible to freeze the offset correction using the serial interface (<OFFSET LOOP FREEZE>). Once frozen, the offset estimation becomes inactive and the last estimated value is used for correction every clock cycle. Note that the offset correction is disabled by default after reset.

Figure 27 shows the time response of the offset correction algorithm, after it is enabled.





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Table 9 Time Constant of Offset Correction Algorithm

| | 1 | |
|---------------------------------|-------------------------------------|--|
| <offset loop="" tc=""></offset> | Time constant (TC _{CLK}), | Time constant, sec |
| D6-D5-D4 | number of clock cycles | (=TC _{CLK} x 1/Fs) ⁽¹⁾ |
| 000 | 227 | 1.1 |
| 001 | 226 | 0.55 |
| 010 | 2 ²⁵ | 0.27 |
| 011 | 224 | 0.13 |
| 100 | 228 | 2.15 |
| 101 | 2 ²⁹ | 4.3 |
| 110 | 227 | 1.1 |
| 111 | 227 | 1.1 |
| | | |

(1) Sampling frequency, Fs = 125 MSPS

TBD

Figure 27 Time Response of Offset Correction

GAIN CORRECTION

ADS62P4X includes option to make fine corrections to the ADC channel gain. The corrections can be done in steps of 0.05 dB, up to a maximum of 0.5 dB, using the register bits <GAIN CORRECTION>. Only positive corrections are supported and the same correction applies to both the channels.

Table 10 Gain Correction Values

| \mathbf{i} | <gain correction=""> D3-D2-D1-D0</gain> | Amount of correction, dB |
|--------------|---|--------------------------|
| V | 0000 | 0 |
| | 0001 | +0.05 |
| | 0010 | +0.1 |
| | 0011 | +0.15 |
| | 0100 | +0.20 |
| | 0101 | +0.25 |
| | 0110 | +0.30 |
| | 0111 | +0.35 |
| | 1000 | +0.40 |
| | 1001 | +0.45 |
| | 1010 | +0.5 |
| | Other combinations | Unused |
| | | |





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DECIMATION FILTER

ADS62P4X includes option to decimate the ADC output data with in-built low pass, high pass or band pass filters.

The decimation rates & the type of filter can be selected using register bits <DECIMATION RATE> & <DECIMATION FILTER TYPE>. Decimation rates of 2, 4 or 8 are available and either low pass, high pass or band pass filters can be selected (Table 11). By default, the decimation filter is disabled - use register bit <DECIMATION ENABLE> to enable it.

| Combination of decimation rates & filter types | | Serial interface settings | | | | | | |
|--|---|---------------------------|-----------------|---|---|-------------------------|---|---|
| Decimation | Type of filter | | CIMATI RATE> | | | /ATION R FREQ ND> | <filter COEFF SELECT></filter | <decimation ENABLE></decimation |
| Decimate by 2 | In-built low pass filter (pass band = 0 to Fs/4) | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| | In-built high pass filter (pass band = Fs/4 to Fs/2) | 0 | 0 | 0 | 0 | 1 | 0 | 1 |
| | In-built low pass filter (pass band = 0 to Fs/8) | 0 | 0 | 1 | 0 | 0 | 0 | 1 |
| Decimate by 4 | In-built 2 nd band pass filter (pass band = Fs/8 to Fs/4) | 0 | 0 | 1 | 0 | 1 | 0 | 1 |
| | In-built 3rd band pass filter (pass band = Fs/4 to 3Fs/8) | 0 | 0 | 1 | 1 | 0 | 0 | 1 |
| Decimate by 4 | In-built last band pass filter (pass band = 3Fs/8 to Fs/2) | 0 | 0 | 1 | 1 | 1 | 0 | 1 |
| | | | | | | | | |
| Decimate by 2 | Custom filter (user programmable coefficients) | 0 | 0 | 0 | х | х | 1 | 1 |
| Decimate by 4 | Custom filter (user programmable coefficients) | 0 | 0 | 1 | х | х | 1 | 1 |
| Decimate by 8 | Custom filter (user programmable coefficients) | 1 | 0 | 0 | х | Х | 1 | 1 |
| No decimation | Custom filter (user programmable coefficients) | 0 | 1 | 1 | х | х | 1 | 0 |

Table 11 Decimation Filter Modes (1)





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Decimation filter equation

The decimation filter is implemented as 24-tap FIR with symmetrical coefficients (each coefficient is 12-bit signed). The filter equation is:

$$y(n) = \left(\frac{1}{2^{11}}\right) \bullet (h0 \bullet x(n) + h1 \bullet x(n-1) + h2 \bullet x(n-2) + ... + h11 \bullet x(n-11) + h11 \bullet x(n-12) + ... + h1 \bullet x(n-22) + h0 \bullet x(n-23))$$

By setting the register bit <ODD TAP ENABLE> = 1, a 23-tap FIR is implemented:

$$y(n) = \left(\frac{1}{2^{11}}\right) \bullet (h0 \bullet x(n) + h1 \bullet x(n-1) + h2 \bullet x(n-2) + \dots + h10 \bullet x(n-10) + h11 \bullet x(n-11) + h10 \bullet x(n-12) + \dots + h1 \bullet x(n-21) + h0 \bullet x(n-22)$$

In the above equations,

- h0, h1 ...h11 are 12 bit signed representation of the coefficients,
- x(n) is the input data sequence to the filter &
- y(n) is the filter output sequence.

Pre-defined coefficients

The in-built filter types (low pass, high pass & band pass) use pre-defined coefficients. The frequency response of the in-built filters is shown in Figure 28 & Figure 29.

TBD

Figure 28 Decimate by 2 filter response

TBD

Figure 29 Decimate by 4 filter response



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| Coefficients | Decimate by 2 | | | | |
|--------------|-----------------|------------------|--|--|--|
| Coefficients | Low pass filter | High pass filter | | | |
| h0 | 23 | -22 | | | |
| h1 | -37 | -65 | | | |
| h2 | -6 | -52 | | | |
| h3 | 68 | 30 | | | |
| h4 | -36 | 66 | | | |
| h5 | -61 | -35 | | | |
| h6 | 35 | -107 | | | |
| h7 | 118 | 38 | | | |
| h8 | -100 | 202 | | | |
| h9 | -197 | -41 | | | |
| h10 | 273 | -644 | | | |
| h11 | 943 | 1061 | | | |
| | | | | | |

Table 12 Pre-defined coefficients for Decimate by 2 filters

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Table 13 Pre-defined coefficients for Decimate by 4 filters

| · | | | | |
|--------------|-----------------|---------------------------|---------------------------|-----------|
| | | Decima | ite by 4 | |
| Coefficients | | 1 st Band-pass | 2 nd Band-pass | High pass |
| | Low pass filter | filter | filter | filter |
| h0 | 17 | -7 | -34 | 32 |
| h1 | -50 | 19 | -34 | -15 |
| h2 | 71 | -47 | -101 | -95 |
| h3 | 46 | 127 | 43 | 22 |
| h4 | 24 | 73 | 58 | -8 |
| h5 | -42 | 0 | -28 | -81 |
| h6 | -100 | 86 | -5 | 106 |
| h7 | -97 | 117 | -179 | -62 |
| h8 | 8 | -190 | 294 | -97 |
| h9 | 202 | -464 | 86 | 310 |
| h10 | 414 | -113 | -563 | -501 |
| h11 | 554 | 526 | 352 | 575 |





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Custom filter coefficients with decimation

The filter coefficients can also be programmed by the user (custom). For custom coefficients, set the register bit <FILTER COEFF SELECT> & load the coefficients (h0 to h11) in registers 1E to 2F using the serial interface (Table 14) as:

Register content = 12 bit signed representation of [real coefficient value x 2¹¹]

Custom filter coefficients without decimation

The filter with custom coefficients can also be used with the decimation mode disabled. In this mode, the filter implementation is 12-tap FIR:

$$y(n) = \left(\frac{1}{2^{11}}\right) \bullet \left(h6 \bullet x(n) + h7 \bullet x(n-1) + h8 \bullet x(n-2) + \ldots + h11 \bullet x(n-5) + h11 \bullet x(n-6) + \ldots + h7 \bullet x(n-10) + h6 \bullet x(n-11)\right)$$

| REGISTER | REGISTER FUNCTIONS | | | | | | | | |
|----------|--|------------------------|-------------|-------------|-----------------------|-----------------------|-------------|----|--|
| ADDRESS | | | | | | | | | |
| A7 - A0 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| in hex | | _ | | | | | | _ | |
| 1E | | | | Coefficien | t h0 <7:0> | | | | |
| 1F | | Coefficier | nt h1 <3:0> | | | Coefficient | t h0 <11:8> | | |
| 20 | | | | Coefficient | h1 <11:4> | | | | |
| 21 | | | | Coefficien | t h2 <7:0> | | | | |
| 22 | | Coefficie | nt h3 <3:0> | | | Coefficient | t h2 <11:8> | | |
| 23 | Coefficient h3 <11:4> | | | | | | | | |
| 24 | Coefficient h4 <7:0> | | | | | | | | |
| 25 | Coefficient h5 <3:0> | | | | Coefficient h4 <11:8> | | | | |
| 26 | | | | Coefficient | : h5 <11:4> | | | | |
| 27 | | | | Coefficien | t h6 <7:0> | | | | |
| 28 | | Coefficie | nt h7 <3:0> | | | Coefficient h6 <11:8> | | | |
| 29 | | | | Coefficient | :h7 <11:4> | | | | |
| 2A | | | | Coefficien | t h8 <7:0> | | | | |
| 2B | | Coefficie | nt h9 <3:0> | | | Coefficient | th8 <11:8> | | |
| 2C | | | | Coefficient | : h9 <11:4> | | | | |
| 2D | | | | Coefficient | :h10 <7:0> | | | | |
| 2E | Coefficient h11 <3:0> Coefficient h10 <11:8> | | | | | | | | |
| 2F | | Coefficient h11 <11:4> | | | | | | | |

Table 14 Register Map for Custom FIR coefficients





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PACKAGE INFORMATION

MECHANICAL DATA







PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| ADS62P42IRGCR | PREVIEW | QFN | RGC | 64 | 2500 | TBD | Call TI | Call TI |
| ADS62P42IRGCT | PREVIEW | QFN | RGC | 64 | 250 | TBD | Call TI | Call TI |
| ADS62P43IRGCR | PREVIEW | QFN | RGC | 64 | 2500 | TBD | Call TI | Call TI |
| ADS62P43IRGCT | PREVIEW | QFN | RGC | 64 | 250 | TBD | Call TI | Call TI |
| ADS62P44IRGCR | PREVIEW | QFN | RGC | 64 | 2500 | TBD | Call TI | Call TI |
| ADS62P44IRGCT | PREVIEW | QFN | RGC | 64 | 250 | TBD | Call TI | Call TI |
| ADS62P45IRGCR | PREVIEW | QFN | RGC | 64 | 2500 | TBD | Call TI | Call TI |
| ADS62P45IRGCT | PREVIEW | QFN | RGC | 64 | 250 | TBD | Call TI | Call TI |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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MECHANICAL DATA



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5-1994.

- B. This drawing is subject to change without notice.
- C. Quad Flatpack, No-leads (QFN) package configuration .
- The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.





THERMAL PAD MECHANICAL DATA

RGC (S-PQFP-N64)

THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No-Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.





NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http://www.ti.com>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for vias placed in thermal pad.



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